AUTOMOTIVE GRADE

Available

COMPLIANT

HALOGEN

FREE



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Vishay General Semiconductor

High Current Density Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low $V_F = 0.35 \text{ V}$ at $I_F = 5 \text{ A}$



LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS			
I _{F(AV)}	10 A		
V _{RRM}	60 V		
I _{FSM}	180 A		
V _F at I _F = 10 A (T _J = 125 °C)	0.47 V		
T _J max.	150 °C		
Package	SMPC (TO-277A)		
Circuit configuration	Single		

FEATURES

- Very low profile typical height of 1.1 mm
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA

Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

PARAMETER	SYMBOL	V10PL63	UNIT	
Device marking code		10L63		
Maximum repetitive peak reverse voltage	V _{RRM}	60	V	
Maximum average forward rectified current (fig. 1)	I _{F(AV)} (1)	10	A	
	I _{F(AV)} (2)	4.6		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	180	А	
Operating junction temperature range	T _J ⁽³⁾	-40 to +150	°C	
Storage temperature range	T _{STG}	-55 to +150	°C	

Notes

- (1) Mounted on 30 mm x 30 mm pad areas aluminum PCB
- (2) Free air, mounted on recommended copper pad area
- $^{(3)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$



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ELECTRICAL CHARACTERISTICS (T _J = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 5.0 A	- T _J = 25 °C	V _F ⁽¹⁾	0.45	-	V
	I _F = 10 A			0.52	0.58	
	I _F = 5.0 A	T _J = 125 °C		0.35	-	
	I _F = 10 A			0.47	0.53	
Reverse current	V _R = 60 V	T _J = 25 °C T _J = 125 °C	T _J = 25 °C	-	0.25	- mA
	v _R = 60 v		125 °C	9	20	
Typical junction capacitance	4.0 V, 1 MHz		CJ	2100	-	pF

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	V10PL63	UNIT		
Turing the arrest registers as	R ₀ JA (1)(2)	75	°C/W		
Typical thermal resistance	R _{0JM} (3)	4			

Notes

(1) The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$

 $^{(2)}$ Free air mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction to ambient

Mounted on 30 mm x 30 mm aluminum PCB; thermal resistance $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
V10PL63-M3/H	0.10	Н	1500	7" diameter plastic tape and reel
V10PL63-M3/I	0.10	I	6500	13" diameter plastic tape and reel
V10PL63HM3/H (1)	0.10	Н	1500	7" diameter plastic tape and reel
V10PL63HM3/I (1)	0.10	1	6500	13" diameter plastic tape and reel

Note

(1) AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

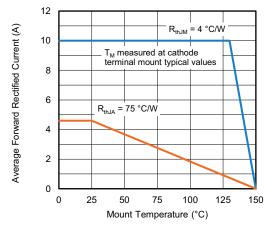


Fig. 1 - Forward Current Derating Curve

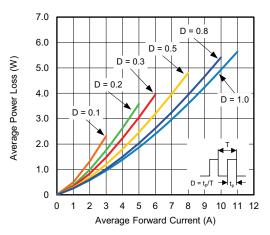


Fig. 2 - Forward Power Loss Characteristics

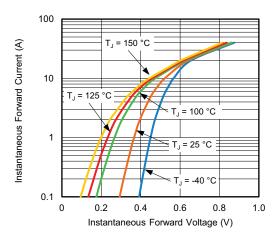


Fig. 3 - Typical Instantaneous Forward Characteristics

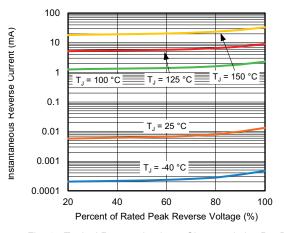


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

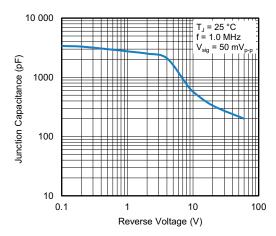


Fig. 5 - Typical Junction Capacitance

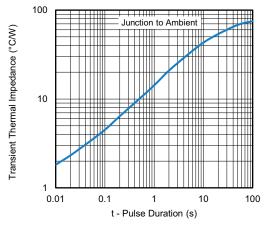
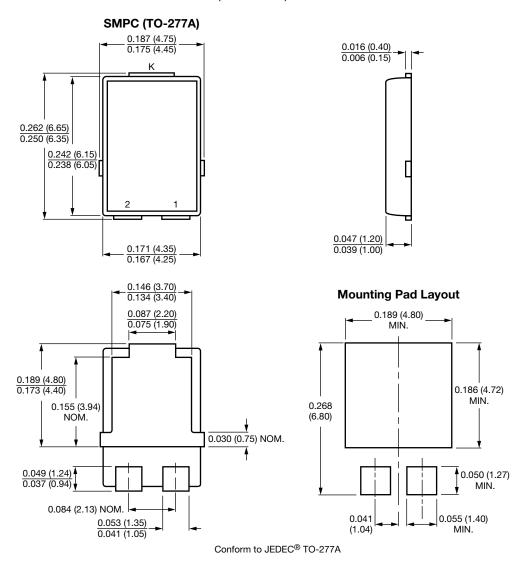


Fig. 6 - Typical Transient Thermal Impedance



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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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